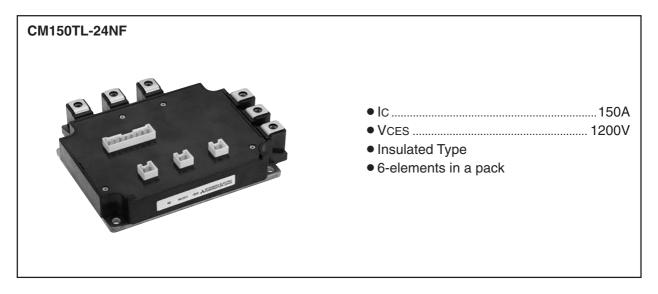
MITSUBISHI IGBT MODULES

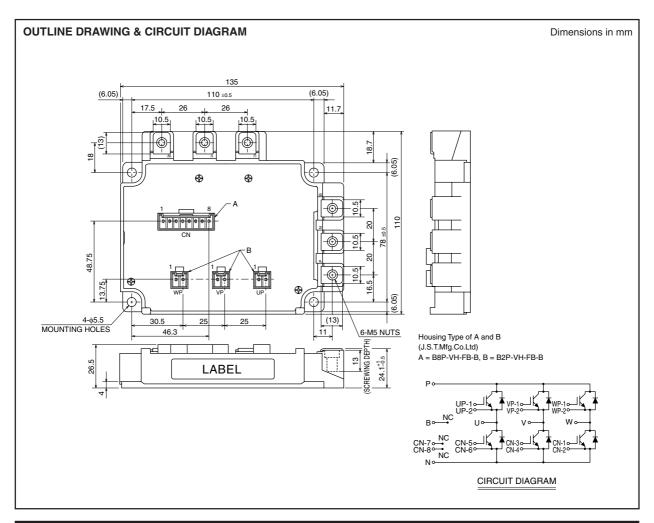
CM150TL-24NF

HIGH POWER SWITCHING USE



APPLICATION

AC drive inverters & Servo controls, etc





HIGH POWER SWITCHING USE

ABSOLUTE MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

| Symbol | Parameter | Conditions | | Ratings | Unit |
|--------------|-------------------------------|--|----------|--------------------|------|
| VCES | Collector-emitter voltage | G-E Short | | 1200 | V |
| VGES | Gate-emitter voltage | C-E Short | | ±20 | V |
| Ic | Collector current | DC, $Tc = 76^{\circ}C^{*1}$ | | 150 | Α |
| Ісм | Collector current | Pulse | (Note 2) | 300 | Α |
| IE (Note 1) | Emitter current | | | 150 | Α |
| IEM (Note 1) | Emilier current | Pulse | (Note 2) | 300 | Α |
| PC (Note 3) | Maximum collector dissipation | Tc = 25°C | | 890 | W |
| Tj | Junction temperature | | | − 40 ~ +150 | °C |
| Tstg | Storage temperature | | | − 40 ~ +125 | °C |
| Viso | Isolation voltage | Terminals to base plate, f = 60Hz, AC 1 minute | Э | 2500 | Vrms |
| _ | To you a patro postle | Main terminals M5 screw | | 2.5 ~ 3.5 | N•m |
| _ | Torque strength | Mounting M5 screw | | 2.5 ~ 3.5 | N•m |
| _ | Weight | Typical value | | 750 | g |

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

| Cumahad | Parameter | Test conditions | | Limits | | | Unit |
|--------------|--------------------------------------|---|------------------------|--------|-------|------|------|
| Symbol | | | | Min. | Тур. | Max. | Unit |
| ICES | Collector cutoff current | VCE = VCES, VGE = 0V | | | _ | 1 | mA |
| VGE(th) | Gate-emitter threshold voltage | IC = 15mA, VCE = 10V | | 6 | 7 | 8 | V |
| IGES | Gate leakage current | ±VGE = VGES, VCE = 0V | | | _ | 0.5 | μΑ |
| VCE(sat) | Collector-emitter saturation voltage | IC = 150A, VGE = 15V | T _j = 25°C | _ | 2.1 | 3.0 | V |
| | | | T _j = 125°C | _ | 2.4 | _ | |
| Cies | Input capacitance | Voc. 10V | | _ | _ | 23 | nF |
| Coes | Output capacitance | VCE = 10V VGE = 0V | | | _ | 2 | nF |
| Cres | Reverse transfer capacitance | | | _ | _ | 0.45 | nF |
| QG | Total gate charge | Vcc = 600V, Ic = 150A, VgE = 15V | | _ | 675 | _ | nC |
| td(on) | Turn-on delay time | Vcc = 600V, Ic = 150A VGE = \pm 15V RG = 2.1Ω , Inductive load | | | _ | 130 | ns |
| tr | Turn-on rise time | | | _ | _ | 70 | ns |
| td(off) | Turn-off delay time | | | | _ | 400 | ns |
| tf | Turn-off fall time | | | | _ | 350 | ns |
| trr (Note 1) | Reverse recovery time | IE = 150A | | | _ | 150 | ns |
| Qrr (Note 1) | Reverse recovery charge | | | | 5.8 | _ | μС |
| VEC(Note 1) | Emitter-collector voltage | IE = 150A, VGE = 0V | | | _ | 3.8 | V |
| Rth(j-c)Q | Thermal resistance | IGBT part (1/6 module)*1 | | | _ | 0.14 | K/W |
| Rth(j-c)R | Thermal resistance | FWDi part (1/6 module)*1 | | | _ | 0.23 | K/W |
| Rth(c-f) | Contact thermal resistance | Case to heat sink, Thermal compound Applied (1/6 module)*2 | | | 0.051 | _ | K/W |
| Rg | External gate resistance | | | | | 31 | Ω |



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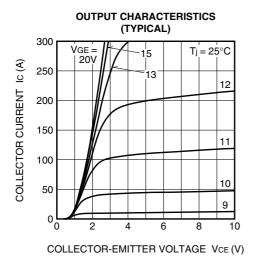
^{*1 :} Case temperature (Tc) measured point is just under the chips.
If you use this value, Rth(f-a) should be measured just under the chips.
*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].

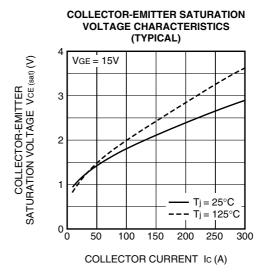
Note 1. IE, VEC, trr & Qrr represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).

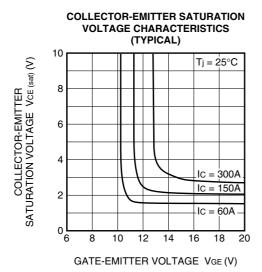
Pulse width and repetition rate should be such that the device junction temperature (Tj) does not exceed T_{jmax} rating.
 Junction temperature (Tj) should not increase beyond 150°C.
 Pulse width and repetition rate should be such as to cause negligible temperature rise.

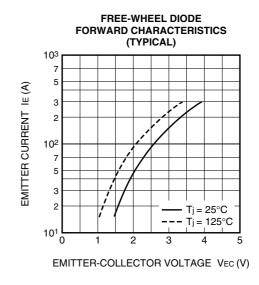
HIGH POWER SWITCHING USE

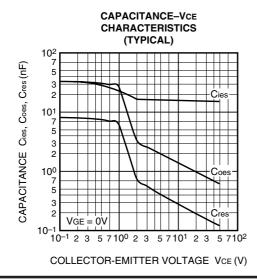
PERFORMANCE CURVES

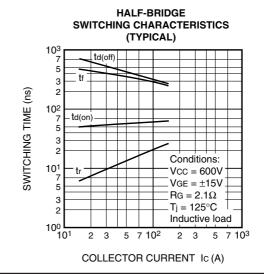












HIGH POWER SWITCHING USE

REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL) 10³ REVERSE RECOVERY CURRENT In (A) REVERSE RECOVERY TIME trr (ns) 5 3 2 10² 7 Conditions: 5 Vcc = 600V $VGE = \pm 15V$ 3 $RG = 2.1\Omega$ 2 $T_i = 25^{\circ}C$ Inductive load 101 L 101

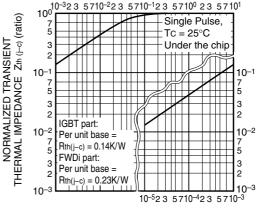
2 3 5 7 102

5 7 103

3

IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part) 10⁻³23 5710⁻²23 5710⁻¹23 5710⁰ 23 5710¹

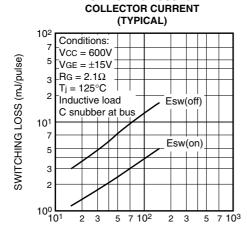
TRANSIENT THERMAL



TIME (s)

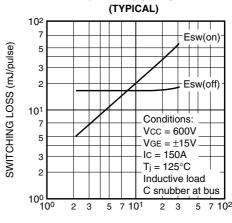
SWITCHING LOSS vs.

EMITTER CURRENT IE (A)

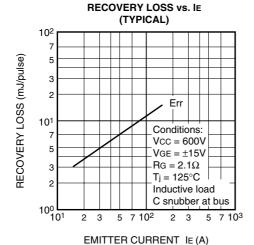


COLLECTOR CURRENT Ic (A)

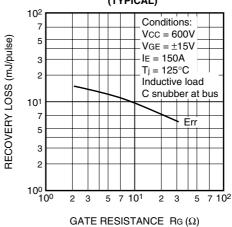
SWITCHING LOSS vs. **GATE RESISTANCE**



GATE RESISTANCE RG (Ω)



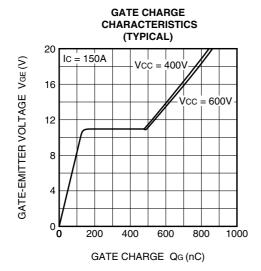
RECOVERY LOSS vs. **GATE RESISTANCE** (TYPICAL)





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HIGH POWER SWITCHING USE





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